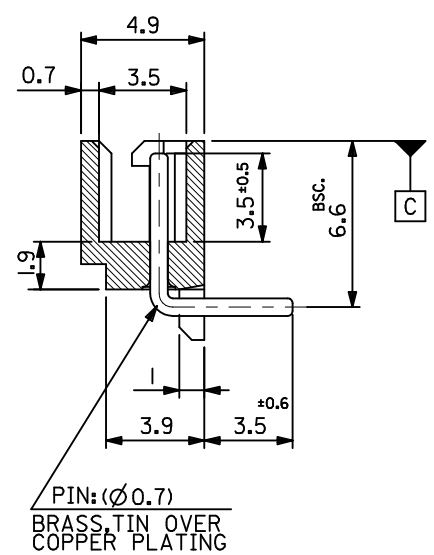
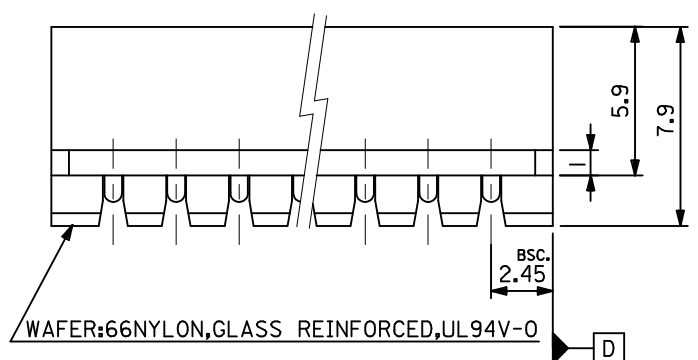
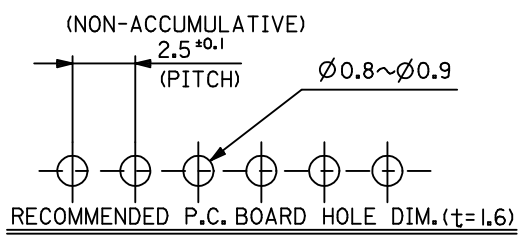


NOTE:
MATES WITH : 5264 SERIES.



39.9	38.5	35	-7155	-15A	15
37.4	36	32.5	-7145	-14A	14
34.9	33.5	30	-7135	-13A	13
32.4	31	27.5	-7125	-12A	12
29.9	28.5	25	-7115	-11A	11
27.4	26	22.5	-7105	-10A	10
24.9	23.5	20	-7095	-09A	9
22.4	21	17.5	-7085	-08A	8
19.9	18.5	15	-7075	-07A	7
17.4	16	12.5	-7065	-06A	6
14.9	13.5	10	-7055	-05A	5
12.4	11	7.5	-7045	-04A	4
9.9	8.5	5	-7035	-03A	3
7.4	6	2.5	22-05-7025	5268-02A	2
C	B	A	EDP NO.	ENG.NO.	CKT.



REVISED EC NO: J2018-0076 2017/08/29 TIDRINKUSATO 2017/08/29 CHKDAIDA 2017/08/30 APPR:TKANEKO	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE MM ONLY	SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	0.25 UNDER ±	DRAWN BY K.TOJO	DATE 1991/11/05	TITLE 2.5 LOW PROFILE WAFER ASSY 90° BEND	
	0.25 OVER 0.5 UNDER ±	CHECKED BY H.HIRAMOTO	DATE 1992/08/31		
	0.5 OVER 1.0 UNDER ±	APPROVED BY M.ENAMOTO	DATE 1992/08/31		
0 OVER 10 UNDER ±0.2	MATERIAL NO.	DOCUMENT NO.	SHEET NO.		
10 OVER 30 UNDER ±0.25	SEE CHART		SD-5268-NA		1 OF 1
30 OVER ±0.3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
ANGULAR ±3°	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				